



PARA LIGHT ELECTRONICS CO., LTD.

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan,

Tel: 886-2-2225-3733

Fax: 886-2-2225-4800

E-mail: para@para.com.tw

www.paralighttaiwan.com

DATA SHEET

PART NO.: L-C191IR1CT

REV: A / 1

CUSTOMER'S APPROVAL : _____

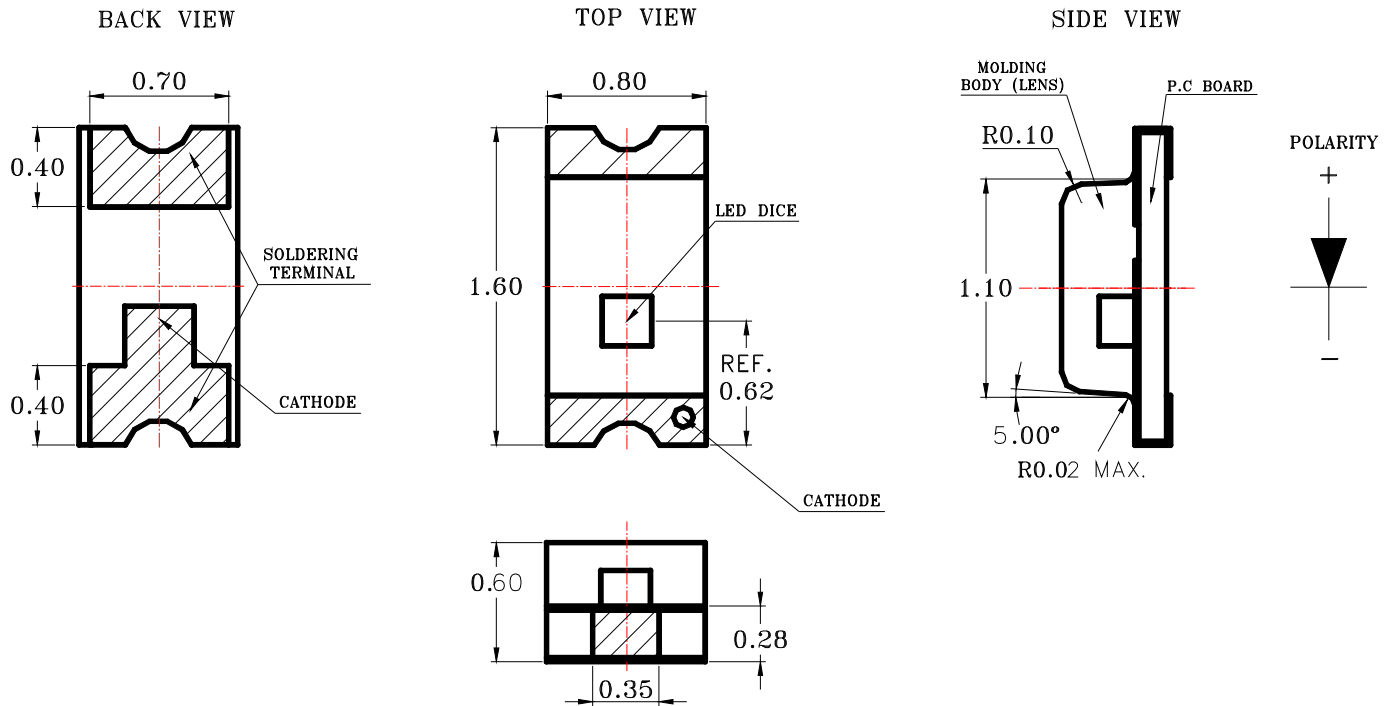
DCC : _____

DRAWING NO. : DS-74-14-0014

DATE : 2016-5-20

PAGE 1 of 13

● PACKAGE OUTLINE DIMENSIONS



Notes:

1. All dimensions are in millimeters.
2. Tolerance is $\pm 0.1\text{mm}$ (.004") unless otherwise noted.

● Features

- * Side looking special for LCD backlight.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Infrared and Wave soldering reflow solder processes.
- * EIA STD package.
- * I.C. compatible.
- * Pb free product.
- * Meet RoHS Green Product.

● **Chip Materials**

- * Dice Material : GaAlAs/GaAs
- * Lens Color : Water Clear

● **Absolute Maximum Ratings(Ta=25°C)**

SYMBOL	PARAMETER	MAX	UNIT
PD	Power Dissipation Per Chip	150	mW
VR	Reverse Voltage Per Chip	5	V
IF	Forward Current Per Chip	100	mA
IPF	Peak forward current Per Chip (F=1KHZ,duty=0.1)	400	mA
Topr	Operating Temperature Range	-25°C to 85°C	
Tstg	Storage Temperature Range	-25°C to 85°C	

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

● **Electro-Optical Characteristics(Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IE	0.45	0.9		mw/sr	IF=20mA
Viewing Angle	2 θ 1/2		130		deg	Note 2
Peak Emission Wavelength	λ p		940		nm	Measurement @Peak
Spectral Line Half-Width	Δ λ		35		nm	
Forward Voltage	VF		1.2	1.4	V	IF =20mA
Reverse Current	IR			10	μ A	VR = 5V



SURFACE MOUNT DEVICE LED

Part No. : L-C191IR1CT

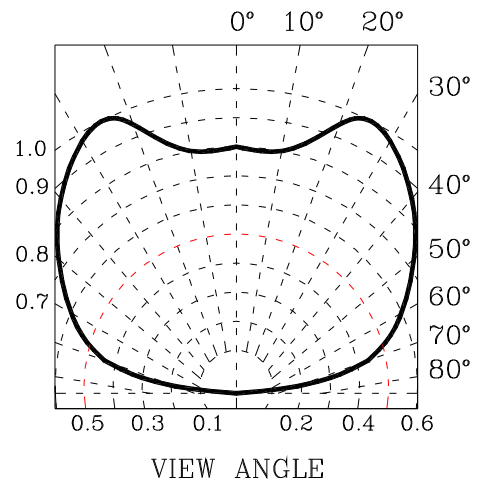
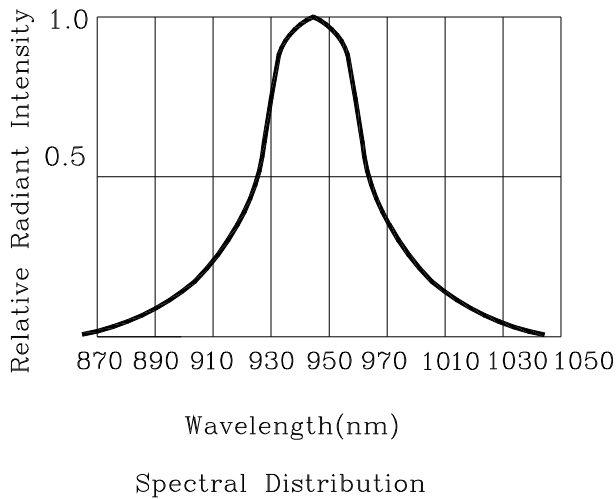
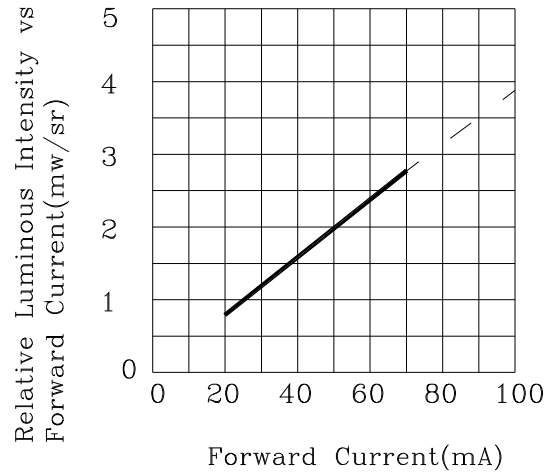
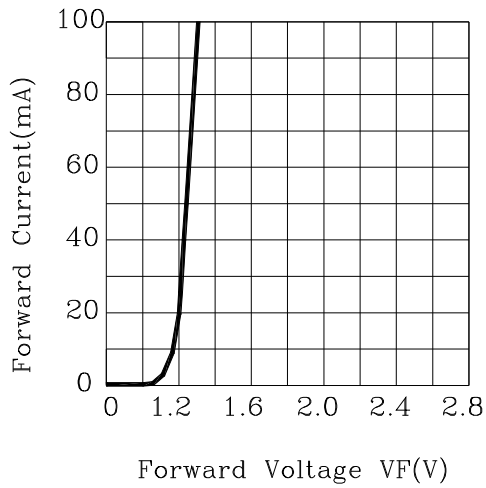
REV:A / 1

Notes:

1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength λ_d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. Caution in ESD :
Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
5. Major standard testing equipment by "Instrument System" Model : CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model : 2400.

● Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)



● Label Explanation



ITEM CODE:PARRA LIGHT

PART NO: L-C191IR1CT

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110
 A B C D E F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

3000pcs for 150、170、110、155、115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE: 2012 09 10
 G H I

G--- Year

H--- Month

I --- Day

● Typical Electro-Optical Characteristics Curves

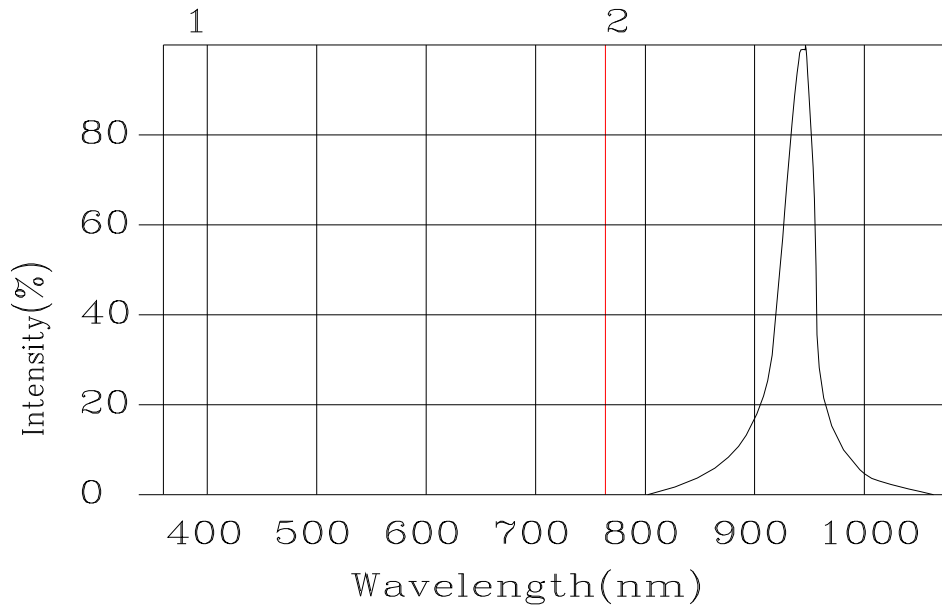
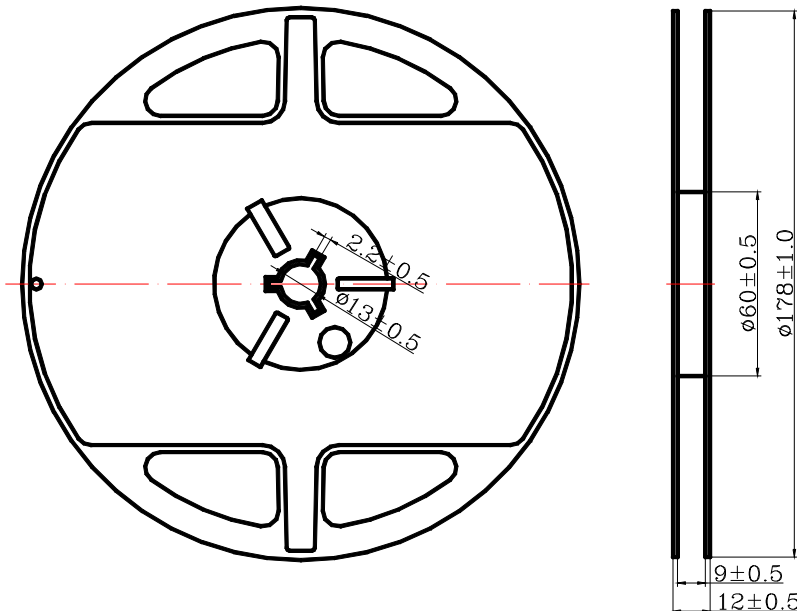


Fig.1 Relative Intensity vs. Wavelength

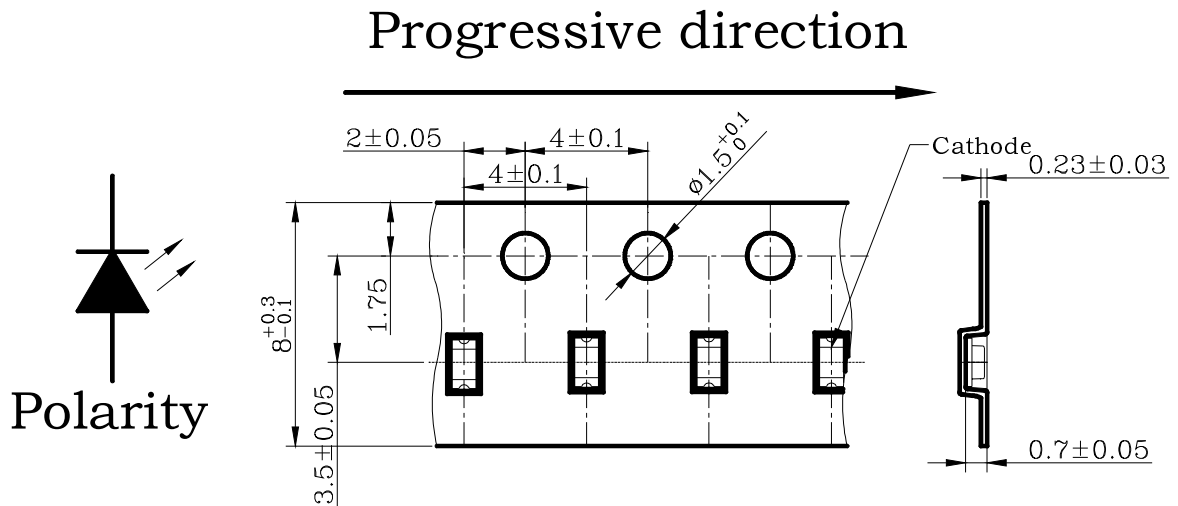
● Reel Dimensions



Notes:

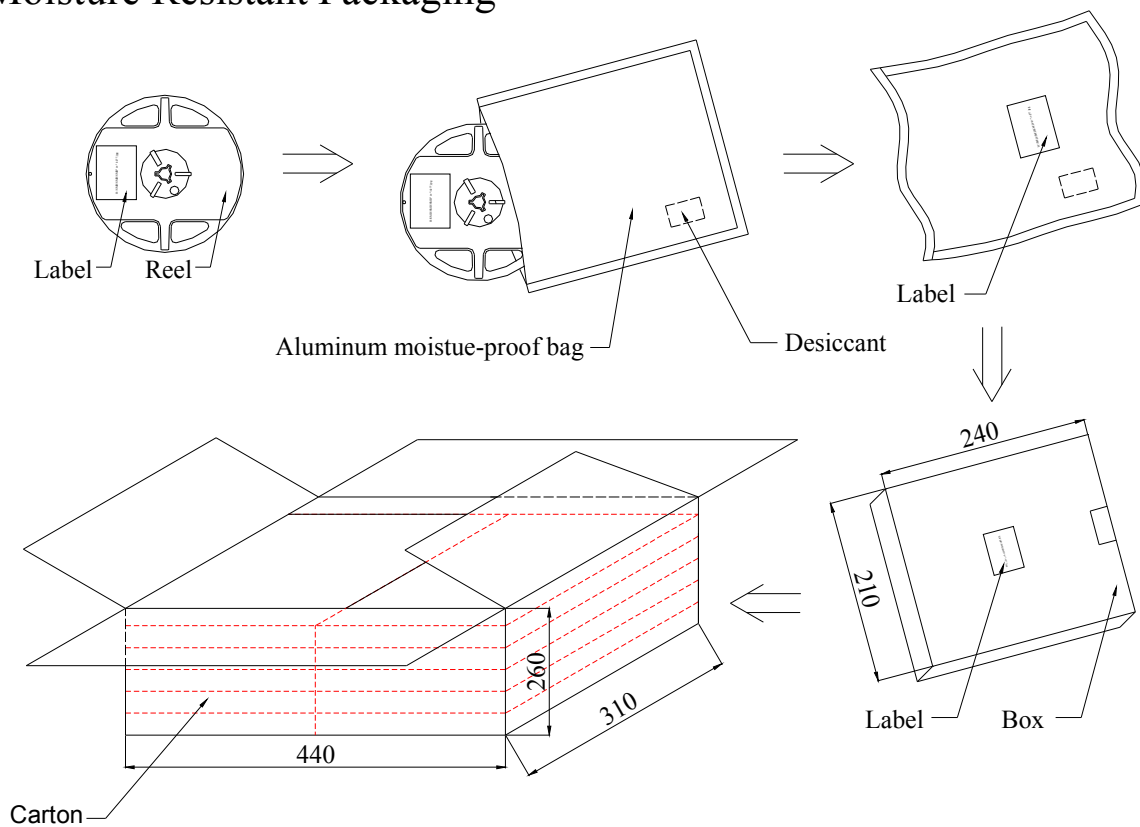
1. Taping Quantity : 4000pcs
2. The tolerances unless mentioned is $\pm 0.1\text{mm}$, Angle $\pm 0.5^\circ$, Unit : mm.

● Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

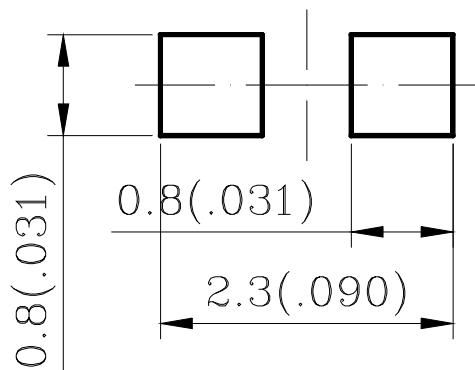
Moisture Resistant Packaging



Notes : One reel in a bag, six bag in a inner box, six inner boxes in a carton. Unit : mm.

● Cleaning

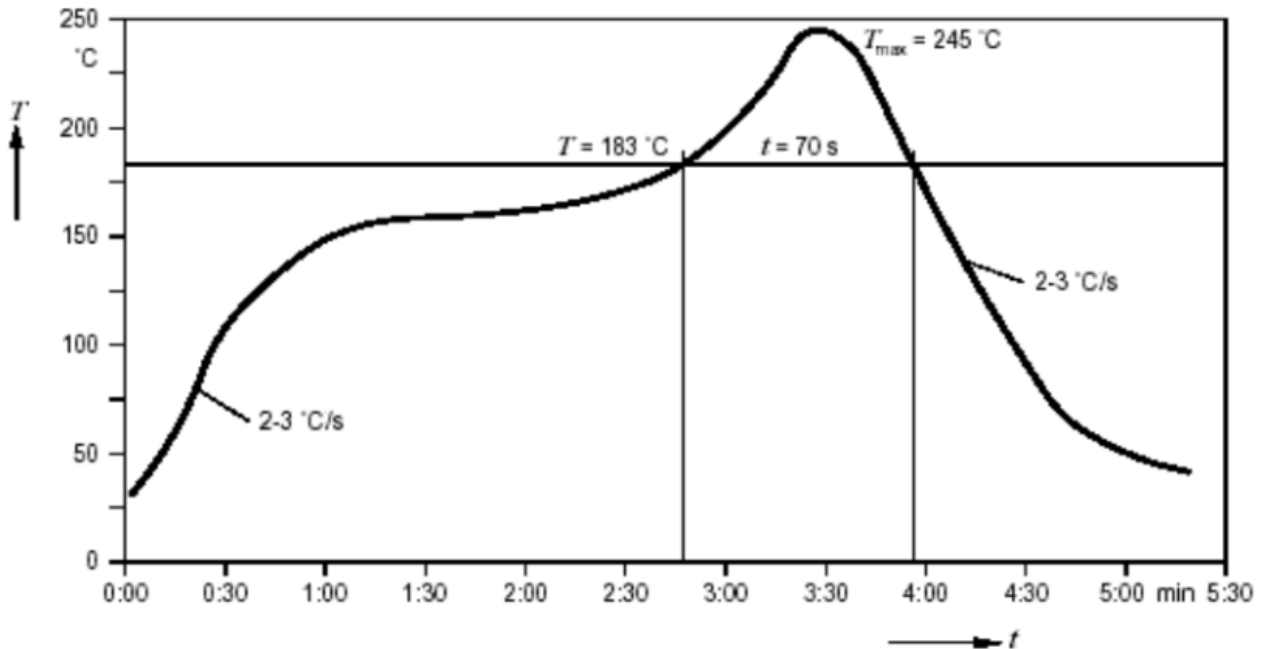
- * If cleaning is required , use the following solutions for less than 1 minute and less than 40°C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- * Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

● Suggest Soldering Pad Dimensions

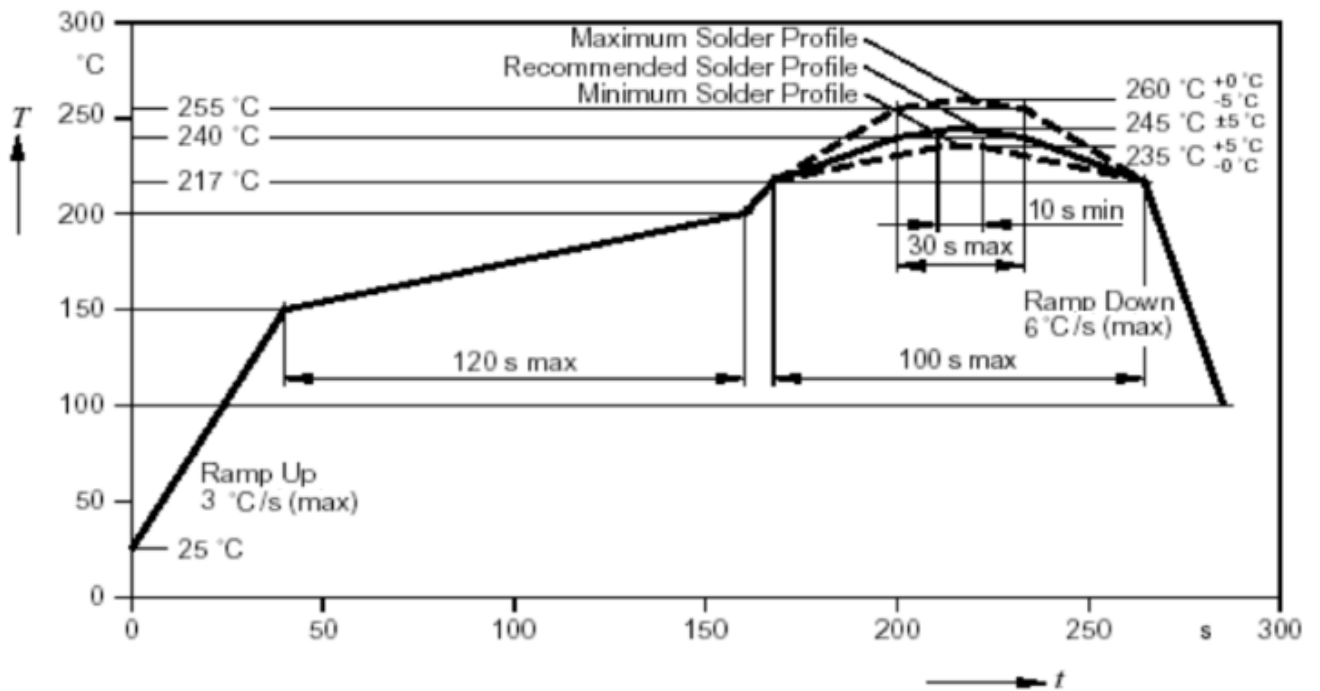
↑
↓

Direction of PWB camber
and go to reflow furnace

● Suggest Sn/Pb IR Reflow Soldering Profile Condition:



● Suggest Pb-Free IR Reflow Soldering Profile Condition:



● CAUTIONS

1. Application Limitation :

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2. Storage :

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

3. Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max.

Soldering Iron : (Not recommended)

Temperature 300°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering :

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

4. Lead-Free Soldering

For Reflow Soldering :

- 1、Pre-Heat Temp:150-180°C,120sec.Max.
- 2、Soldering Temp:Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3、Peak Temperature:260°C、5sec.
- 4、Reflow Repetition:2 Times Max.
- 5、Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

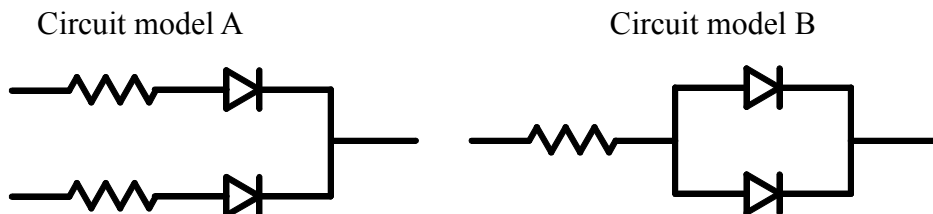
For Soldering Iron (Not Recommended) :

- 1、Iron Tip Temp:350°C Max.
- 2、Soldering Iron:30w Max.
- 3、Soldering Time:3 Sec. Max. One Time.

For Dip Soldering :

- 1、Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2、Bath Temp:265°C Max.
- 3、Dip Time:5 Sec. Max.

5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.



SURFACE MOUNT DEVICE LED

Part No. : L-C191IR1CT

REV:A / 1

6. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C, RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= 105±5°C Test Time= 1000HRS (-24HRS,72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,72H RS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	105±5°C -55±5°C 10mins 10mins 100 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times 105±5°C -55°C±5°C 10mins 10mins 100 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Solder Resistance	Tsol= 260 ± 5°C Dwell Time= 10 ± 1sec	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
	Solder ability	Tsol= 235 ± 5°C Immersion time 2±0.5 sec Immersion rate 25±2.5 mm/sec Coverage ≥95% of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

7. Others:

The appearance and specifications of the product may be modified for improvement without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Infrared Emitters](#) category:

Click to view products by [Para Light](#) manufacturer:

Other Similar products are found below :

[LTE-309](#) [LTE-3279K](#) [LTE-4206C](#) [LTE-4208C](#) [EE-L105-X](#) [K3N](#) [QED123UL](#) [LTE-2871C](#) [LTE-2872U](#) [LTE-4238](#) [ASDL-4264-C22](#)
[TSHA6201](#) [TSHA6202](#) [HSDL-4400031](#) [EAIPL3528Z0](#) [OED-EL305F4C50-HT](#) [TSUS6202](#) [OP216-004](#) [VSMY98145DS](#) [VSMY99445DS](#)
[HL-PST-1608IR1C-L4](#) [IN-S126ETIR](#) [IN-S126DSHIR](#) [IN-S126ETHIR](#) [IN-P32ZTHIR](#) [IN-S126BTHIR](#) [IN-S63DTHIR](#) [IN-S85BTHIR](#) [IN-S63FTHIR](#) [E6C0805IRAC1UDA940nm](#) [HIR204C/H0](#) [HIR204/H0](#) [HIR323C](#) [LTE-209](#) [TSML1030](#) [IR12-21C/TR8](#) [IR17-21C/TR8](#) [IR383](#)
[IR91-21C/TR10](#) [WP7113F3BT](#) [SFH 4948](#) [SFH 4949](#) [LTE-4208](#) [OP235W](#) [OP297FAB](#) [TSHA5201](#) [TSHA5500](#) [TSTS7500](#) [TSUS5201](#)
[TSUS5401](#)